

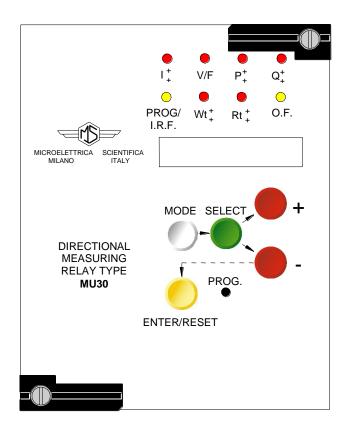
Doc. N° MO-0139-ING

Rev. 0

Pag. 1 of 32

MICROPROCESSOR CONTROLLED MEASUREMENT AND SUPERVISION UNIT TYPE MU30-LP

OPERATION MANUAL



((



Doc. N° MO-0139-ING

Rev. 0

Pag. **2** of **32**

INDEX

1. Consult utilization and commissioning directions	3
3	3
	3
	3
	3
1.5 Outputs loading	3
J	3
1.7 Setting and calibration	3
1.8 Safety protection	3
1.9 Handling	3
	4
	4
	4
3 Controls and measurements	5
	6
5 Output relays	
	7
	8
8 Test	-
	9
10 Reading of measurements and recorded parameters	
ACT. MEAS (Actual measure)	10
MAX VAL (Max values)	13
LASTTRIP (Last trip)	14
TRIP NUM (Trip number)	14
11 Reading of programmed settings and relay's configuration	15
12 Programming	
12.1 Programming of functions settings	15
12.2 Programming the configuration of output relay	18
13 Manual and automatic test operation	19
13 Manual and automatic test operation 13.1 Mode "TESTPROG" subprogram "W/O TRIP" 13.2 Mode "TESTPROG" subprogram "W/ithTRIP"	19
13.2 Mode "TESTPROG" subprogram "WithTRIP"	19
14 Maintenance	19
15 Power frequency insulation test	19
	20
16.1 Clock synchronization	
16.2 Date and time setting	
16.3 Time resolution	20
16.4 Operation during power off	20
16.5 Time tolerance	20
17 Time stamping of maximum demand values	21
18 Energy measurements - Algorithms	21
	23
19.1 Reading of the demand recording data	23
20 Electrical characteristics	25
21 Connection diagram (Standard Output)	26
21.1 Connection Diagram (Double Output)	26
22 Wiring the serial communication bus	27
23 Overall dimensions	28
24 Direction for pcb's draw-out and plug-in	29
	29
24.2 Plug-in	29
25 Keyboard operational diagram	30
26 Setting's form- Commissioning Test Record	31

20



Doc. N° MO-0139-ING

Rev.

Pag. 3 of 32

1. General utilization and commissioning directions

Always make reference to the specific description of the product and to the Manufacturer's instruction.

Carefully observe the following warnings.

1.1 - STORAGE AND TRANSPORTATION,

must comply with the environmental conditions stated on the product's instruction or by the applicable IEC standards.

1.2 - INSTALLATION,

must be properly made and in compliance with the operational ambient conditions stated by the Manufacturer.

1.3 - ELECTRICAL CONNECTION,

must be made strictly according to the wiring diagram supplied with the Product, to its electrical characteristics and in compliance with the applicable standards particularly with reference to human safety.

1.4 - MEASURING INPUTS AND POWER SUPPLY,

carefully check that the value of input quantities and power supply voltage are proper and within the permissible variation limits.

1.5 - OUTPUTS LOADING,

must be compatible with their declared performance.

1.6 - PROTECTION EARTHING

When earthing is required, carefully check its efficiency.

1.7 - SETTING AND CALIBRATION

Carefully check the proper setting of the different functions according to the configuration of the protected system, the safety regulations and the co-ordination with other equipment.

1.8 - SAFETY PROTECTION

Carefully check that all safety means are correctly mounted, apply proper seals where required and periodically check their integrity.

1.9 - HANDLING

Notwithstanding the highest practicable protection means used in designing M.S. electronic circuits, the electronic components and semiconductor devices mounted on the modules can be seriously damaged by electrostatic voltage discharge which can be experienced when handling the modules.

The damage caused by electrostatic discharge may not be immediately apparent but the design reliability and the long life of the product will have been reduced. The electronic circuits reduced by M.S. are completely safe from electrostatic discharge (8 KV IEC 255.22.2) when housed in their case; withdrawing the modules without proper cautions expose them to the risk of damage.



Doc. N° MO-0139-ING

Rev. C

Pag. 4 of 32

- a. Before removing a module, ensure that you are at the same electrostatic potential as the equipment by touching the case.
- b. Handle the module by its front-plate, frame, or edges of the printed circuit board. Avoid touching the electronic components, printed circuit tracks or connectors.
- c. Do not pass the module to any person without first ensuring that you are both at the same electrostatic potential. Shaking hands achieves equipotential.
- d. Place the module on an antistatic surface, or on a conducting surface which is at the same potential as yourself.
- e. Store or transport the module in a conductive bag.

More information on safe working procedures for all electronic equipment can be found in BS5783 and IEC 147-OF.

1.10 - MAINTENANCE

Make reference to the instruction manual of the Manufacturer; maintenance must be carried-out by specially trained people and in strict conformity with the safety regulations.

1.11 - FAULT DETECTION AND REPAIR

Internal calibrations and components should not be alterated or replaced. For repair please ask the Manufacturer or its authorized Dealers.

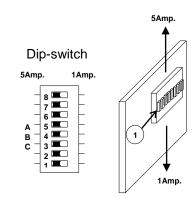
Misapplication of the above warnings and instruction relieves the Manufacturer of any liability.

2. GENERAL CHARACTERISTICS

Input quantities are supplied to 3 current transformers and 3 potential transformers respectively measuring phase currents and phase-to-neutral voltages.

Phase current input can be 1 or 5A (movable jumpers on relay's card). Rated voltage input can be programmed from 100 to 125V (phase to phase) 50 or 60Hz.

Make electric connection in conformity with the diagram reported on relay's enclosure. Check that input currents are same as reported on the diagram and on the test certificate. The auxiliary power is supplied by a built-in interchangeable module fully isolated and self protected. Input rated current can be set to 1 or 5A by 3 dip-switches provided on relay's card (A-B-C).



2.1 AUXILIARY POWER SUPPLY

The relay can be fitted with two different types of **power supply module**:

Before energizing the unit check that supply voltage is within the allowed limits.



Doc. N° MO-0139-ING

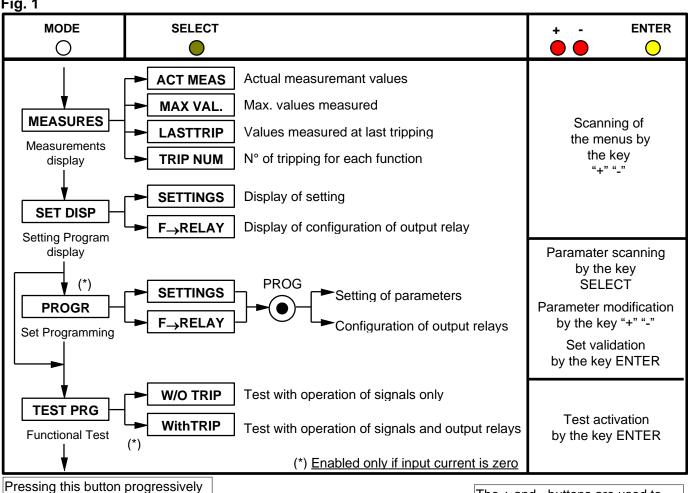
Rev.

of **32** Pag. 5

3. CONTROLS AND MEASUREMENTS

Five key buttons allow for local management of all relay's functions. A 8-digit high brightness alphanumerical display shows the relevant readings (xxxxxxx) (see synoptic table fig.1)

Fig. 1



selects between Measurements Display, Setting Display, Programming, and Test modes

The SELECT button chooses which category of values within the chosen mode to display

When in Program mode, this button stores the newly selected value. If not in Program mode and the relay has tripped, this button resets the relay and all output contacts. If not tripped, this button restores the default display.

MODE SELECT PROG. ENTER/RESET

The + and - buttons are used to select the actual measurement or display desired when in Measurements Display or Settings Display modes. When in Program mode, these buttons increase or decrease the value of the displayed setting.

When in Program mode, and when all input currents are zero. pressing this recessed button places the relay into active programming mode, allowing any or all of the relay's settings to be altered.



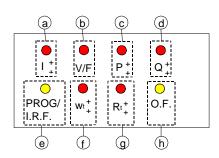
Doc. N° MO-0139-ING

Rev. C

Pag. 6 of 32

4. SIGNALIZATIONS

Eight signal leds (normally off) are provided:



- a) Red LED I H + Illuminated on trip of one of the current elements (under, over or under-over current).
- b) Red LED **V/F**Ulluminated on trip of one of the voltage or frequency elements (under, over or under-over voltage or frequency).
- c) Red LED P + Ulluminated on trip of one of the active power elements (under, over or under-over active power).
- d) Red LED Q + □ Same as above, related to reactive power.
- e) Yellow LED **PROG/IRF**

 Flashing during relay programming or internal fault.

 Illuminated on Internal Fault
- f) Red LED $W_t \stackrel{+}{=} \Box$ Same as above, related to reactive energy.
- g) Red LED Rt + Illuminated on trip of one of the active energy elements (active energy integrated over a definite time above a trip level set by user).
- h) Yellow LED **O.F.** Flashing on overflow of any of the measured quantities.

The reset of the leds takes place as follows

- □ Leds a,b,c,d,f,g □ From illuminated to off, by ENTER/RESET push button or via the serial communication interface, when the lit-on cause has disappeared.
- □ Leds e,h □ From flashing to off, automatically when the lit-on cause disappears.

In case of power supply failure the status of the leds is recorded and reproduced when power supply is restored.



Doc. N° MO-0139-ING

Rev. (

Pag. **7** of **32**

5. OUTPUT RELAYS

Five output relays are available (R1, R2, R3, R4, R5).

- The relays R1,R2,R3,R4 are normally deenergized (energized on trip): these relays are user programmable and any of them can be associated to one of the MU30 functions. In case a relay is associated to more than one element, it gets energized when any of such elements trips and can be deenergized only when all the tripping causes have disappeared. Reset can be programmed as "AUTOMATIC" or "MANUAL". In "AUTOMATIC" mode reset takes place as soon as the trip cause disappears. In "MANUAL" mode a reset command has to be issued to the relay (by the "ENTER/RESET" push button or via the serial communication interface).
- □ All the output relays not associated to any of the MU30 functions can be remotely energized / deenergized via the serial communication interface.
- Pulse output for external energy counters. The R3 output relay can be configured to toggle its status with a frequency which is proportional to the currently measured active power. A 1Hz square wave corresponds to the nominal active power.
 If R3 is employed for this particular function, it can't be associated to any other element.
- □ The relay **R5**, normally energized, is not programmable and is deenergized on:
 - ✓ Internal fault.
 - ✓ Power supply failure.
 - ✓ During the programming.

6. SERIAL COMMUNICATION (Optional: see relevant instruction manual).

The relays fitted with the serial communication option can be connected via a cable bus or (with proper adapters) a fiber optic bus for interfacing with a Personal Computer (type IBM or compatible).

All the operations which can be performed locally (for example reading of measured data and changing of relay's settings) are also possible via the serial communication interface.

Furthermore the serial port allows the user to read the oscillographic recording data.

The unit has at RS232 / RS485 interface and can be connected either directly to a P.C. via a dedicated cable or to at RS485 serial bus, thus having many relays to exchange data with a single master P.C. using the same physical serial line. At RS485/232 converter is available on request.

The communication protocol is MODBUS RTU (only functions 3, 4 and 16 are implemented). Each relay is identified by its programmable address code (NodeAd) and can be called from the P.C.

A dedicated communication software (MSCOM) for Windows 95/98 is available.

Please refer to the MSCOM instruction manual for more information.



Doc. N° MO-0139-ING

Rev. (

Pag. **8** of **32**

7. DIGITAL INPUTS.

The relay is fitted with three digital inputs activated when the relevant terminals are shorted by a cold contact:

- □ **AM** (terminals 1-2) : MAX VAL reset. When this input is activated all the recorded maximum values are instantaneously reset.
- TR (terminals 1-3): Start/stop toggle input for Demand recording. When this input is activated the built-in demand recorder is started (if not running) or stopped (if running) (see § 16).
- □ **SO** (terminals 1-14) : Synchro. When this input is activated, the unit's clock-calendar is synchronized (see § 15).

8. TEST

Besides the normal "WATCHDOG" and "POWERFAIL" functions, a comprehensive program of self-test and self-diagnostic provides:

- Diagnostic and functional test, with checking of program routines and memory's content, run every time the aux. power is switched-on: the display shows the type of relay and its version number.
- Dynamic functional test run during normal operation every 15 min. (relay's operation is suspended for less than 4 ms). If any internal fault is detected, the display shows a fault message, the Led "PROG/IRF" illuminates and the relay R5 is deenergized.
- Complete test activated by the keyboard or via the communication bus either with or without tripping of the output relays.



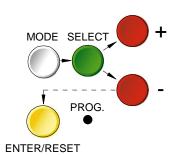
Doc. N° MO-0139-ING

Rev. (

Pag. 9 of 32

9. KEYBOARD AND DISPLAY OPERATION

All controls can be operated from relay's front or via serial communication bus. The keyboard includes five hand operable buttons (MODE) - (SELECT) - (+) - (-) - (ENTER/RESET) plus one indirect operable key (PROG) (see synoptic table a fig.1):



a) - White key **MODE** : when operated it enters one of the following operation modes indicated on the display :

indicated on the diopidy

MEASURES = Reading of all the parameters measured and of those recorded

in the memory

SET DISP = Reading of the settings and of the configuration of the output

relays as programmed.

PROG = Access to the programming of the settings and of relay

configuration.

TEST PROG = Access to the manual test routines.

b) - Green key **SELECT** When operated it selects one of the menus available in the

actual operation MODE

When operated they allow to scroll the different information

- Red key "+" AND "-" : available in the menu entered by the key SELECT and to

increase-decrease the settings.

d) - Yellow key **ENTER/RESET** : It allows the validation of the programmed settings

- the actuation of test programs

- the forcing of the default display indication

- the reset of signal Leds.

e) - Indirect key : Enables access to the programming.



Doc. N° MO-0139-ING

Rev. 0

Pag. 10 of 32

10 READING OF MEASUREMENTS AND RECORDED PARAMETERS

Enter the MODE "MEASURE", SELECT the menus "ACT.MEAS"-"MAX VAL"-"LASTTRIP" -"TRIP NUM", scroll available information by key "+" or "-".

Pushing the ENTER button while the ACT. MEAS menu is active makes the relay enter the AUTOMATIC DISPLAY SCROLLING mode. While running in this mode the unit cyclically displays all the available measurements for 5s each. If the ENTER button is pressed again, the relay switches back to the normal display mode (the UP and DOWN buttons have to be pressed to scroll the menu).

10.1 ACT.MEAS (Actual Measurement values)

Actual values as measured during the normal operation. The values displayed are continuously refreshed.

Display	Description		
xxxxxxx	Current date in the DDMMMYY format.		
xx:xx:xx	Current time in the HH:MM:SS format.		
Fxx.xxHz	nput Frequency		
IA xxxxxA	True R.M.S. value of the phase A current displayed as primary Amps.		
IB xxxxx A	As above, phase B		
IC xxxxx A	As above, phase C		
Ixxxxxx A	Average phase current ((IA+IB+IC)/3)		
EA xxxxx V			
EAxx.xKV	True R.M.S. value of the phase A voltage (phase to neutral), displayed as primary volts (or kV).		
EA xxxKV			
EB xxxxx V			
EBxx.xKV	As above, phase B		
EB xxxKV			
EC xxxxx V			
ECxx.xKV	As above, phase C		
EC xxxKV			
ExxxxxxV			
E x.xxKV	Average phase to neutral voltage ((EA+EB+EC)/3), displayed as primary volts (or kV)		
E xxxKV			
UABxxxxV	To a DMO and a still a A to D selfons. People and an advance of the (colly)		
UABxx.xK	True R.M.S. value of the A to B voltage displayed as primary volts (or kV)		
UAB xxxK			
UBCxxxxV	True D.M.C. value of the D.te. C. valte as disaltered as a simple valte (early)		
UBCxx.xK	True R.M.S. value of the B to C voltage displayed as primary volts (or kV)		
UBC xxxK			
UCAxxxxV UCAxx.xK	True R.M.S. value of the C to A voltage displayed as primary volts (or kV)		
UCAXX.XK	True N.IVI.S. value of the G to A voltage displayed as phillary volts (of KV)		
UxxxxxxV			
U x.xxxk	Average phase to phase voltage displayed as primary volts (or kV).		
U xxxxK	Trivorage priace to priace voltage displayed as primary volts (or kv).		
U XXXXI			



Doc. N° MO-0139-ING

Rev. 0

Pag. 11 of 32

Display	Description		
PFAx.xx	Phase A power factor		
PFBx.xx	As above, phase B		
PFCx.xx	As above, phase C		
PF x.xx	Average power factor ((PFA + PFB + PFC)/3)		
SAXXXXXK			
SAxxx.xM	Apparent power of phase A, displayed as primary kVA (or MVA or GVA)		
SAxxxxxM			
SAxxx.xG			
SBxxxxxK			
SBxxx.xM	As above, phase B		
SBxxxxxM			
SBxxx.xG			
SCxxxxK			
SCxxx.xM	As above, phase C		
SCxxxxxM			
SCxxx.xG			
S xxxxxK			
S xxx.xM	Total apparent power (SA + SB + SC), displayed as primary kVA (or MVA or GVA)		
S xxxxxM			
S xxx.xG			
PA xxxxK			
PA xx.xM	Active power of phase A, displayed as primary kW (or MW or GW)		
PA xxxxM			
PA xx.xG			
PB xxxxK	As above phase D		
PB xx.xM	As above, phase B		
PB xxxxM			
PB xx.xG PC xxxxK			
PC xx.xM	As above, phase C		
PC xxxxM	no above, phase o		
PC xx.xG			
PxxxxxK			
P xxx.xM	Total active power (PA + PB + PC) displayed as primary kW (or MW or GW)		
P xxxxxM			
P xxx.xG			
QA xxxxK			
QA xx.xM	Reactive power of phase A, displayed as primary kVAR (or MVAR or GVAR)		
QA xxxxM			
QA xx.xG			
QB xxxxK			
QB xx.xM	As above, phase B		
QB xxxxM			
QB xx.xG			
QB xx.xG			



Doc. N° MO-0139-ING

Rev. 0

Pag. **12** of **32**

Display	Description	
QC xxxxK	Decempaten	
QC xx.xM	As above, phase C	
QC xxxxM		
QC xx.xG		
Q xxxxxK		
Q xxx.xM	Total reactive power (SA + SB + SC) displayed as primary kVAR (or MVAR or GVAR)	
Q xxxxxM		
Q xxx.xG		
Wh xxxKh		
Wh x.xMh		
Wh xxxMh	Total active energy, displayed as kWh (or MWh or GWh)	
Wh x.xGh		
Wh xxxGh		
Rh xxxKh		
Rh x.xMh		
Rh xxxMh	Total reactive energy, displayed as KVARh (or MVARh or GVARh)	
Rh x.xGh		
Rh xxxGh		
Wt xxxKh		
Wt x.xMh		
Wt xxxMh	Active energy (integrated over a definite time T _{int}), displayed as kWh (or MWh or GWh)	
Wt x.xGh		
Wt xxxGh		
Rt xxxKh		
Rt x.xMh		
Rt xxxMh	Reactive energy (integrated over a definite time T _{int}), displayed as kVARh (or MVARh or GVARh)	
Rt x.xGh		
Rt xxxGh		



Doc. N° MO-0139-ING

Rev. C

Pag. 13 of 32

10.2 MAX VAL (Maximum Values measured)

Time stamped maximum demand values (reset can be done via the AM digital input or the serial communication interface).

Display	Description		
XXXXXXX	Date of the last MAX VAL reset (in the DDMMMYY format)		
xx:xx:xx	Time of the last MAX VAL reset (in the HH:MM:SS format)		
IA XXXXX A	Maximum phase A current, displayed as primary A		
xx:xx:xx	Time between the last MAX VAL reset and the recording of the IA maximum demand value.		
IB xxxxx A	Maximum phase A current, displayed as primary A		
xx:xx:xx	Time between the last MAX VAL reset and the recording of the IB maximum demand value.		
IC XXXXXA	Maximum phase C current, displayed as primary A		
xx:xx:xx	Time between the last MAX VAL reset and the recording of the IC maximum demand value.		
S xxxxxK			
S xxx.xM	Maximum total apparent power, displayed as primary KVA (or MVA or GVA)		
S xxxxxM			
S xxx.xG			
xx:xx:xx	Time between the last MAX VAL reset and the recording of the S maximum demand value.		
P xxxxxK			
P xxx.xM	Maximum total active power, displayed as primary kW (or MW or GW)		
P xxxxxM			
P xxx.xG			
xx:xx:xx	Time between the last MAX VAL reset and the recording of the P maximum demand value.		
Q xxxxxK	Marian and stall and the same of the same		
Q xxx.xM	Maximum total reactive power, displayed as primary KVAR (or MVAR or GVAR)		
Q xxxxxM			
Q xxx.xG	Time het ween the lest MAY VAL recet and the recentling of the Organization of the Organization		
XX:XX:XX	Time between the last MAX VAL reset and the recording of the Q maximum demand value.		
WtxxxxKh Wt x.xMh	Maximum value of active energy integrated over a definite time, displayed as primary kWh (or MWh		
Wt xxxMh	Maximum value of active energy integrated over a definite time, displayed as primary kWh (or MWh or GWh)		
Wt x.xGh	or Gyvii)		
Wt xxxGh			
xx:xx:xx	Time between the last MAX VAL reset and the recording of the Wt maximum demand value.		
RtxxxxKh	g g down and taken		
Rt x.xMh	Maximum value of reactive energy integrated over a definite time, displayed as primary kVARh (or		
Rt xxxMh	MVARh or GVARh)		
Rt x.xGh	'		
Rt xxxGh			
xx:xx:xx	Time between the last MAX VAL reset and the recording of the Rt maximum demand value.		



Doc. N° MO-0139-ING

Rev. 0

Pag. 14 of 32

10.3 LASTTRIP (Values measured al last tripping)

Display of the function which caused the tripping of the relay plus values of the parameters at the moment of tripping.

Display	Description
Cau:xxxx	Function which produced the last event being displayed: f1, f2, u1, u2, i1, i2, p1, p2, q1, q2, s1, s2, w1, w2, r1, r2
Fxx.xxHz	Frequency
IA XXXXX A	Phase A current, displayed as primary A
IB xxxxx A	As above, phase B
ICxxxxxA	As above phase C
EA xxxxxV	
EAxx.xKV	Phase A voltage, displayed as primary V (or kV)
EA xxxKV	
EB xxxxx V	
EBxx.xKV	As above, phase B
EB xxxKV	
EC xxxxxV	
ECxx.xKV	As above, phase C
EC xxxKV	
PFAx.xx	Phase A power factor
PFBx.xx	Phase B power factor
PFCx.xx	Phase C power factor

10.4 TRIP NUM (N° of tripping for each function)

Counters of the number of operations for each of the relay functions. The memory is non-volatile and be cancelled only with a secret procedure.

Display	Description
1uxxxxxx	1st voltage element
2uxxxxxx	2 nd voltage element
1fxxxxxx	1st frequency element
2fxxxxxx	2 nd frequency element
1ixxxxxx	1 st current element
2ixxxxxx	2 nd current element
1pxxxxxx	1 st active power element
2pxxxxxx	2 nd active power element
1qxxxxxx	1 st reactive power element
2qxxxxxx	2 nd reactive power element
1sxxxxxx	1st apparent power element
2sxxxxxx	2 nd apparent power element
1wxxxxxx	1 st active power element
2wxxxxxx	2 nd active power element
1rxxxxxx	1 st reactive power element
2rxxxxxx	2 nd reactive power element



Doc. N° MO-0139-ING

Rev. 0

Pag. **15** of **32**

11. READING OF PROGRAMMED SETTINGS AND RELAY'S CONFIGURATION

Enter the mode "SET DISP", select the menu "SETTINGS" or "F \rightarrow RELAY", scroll information available in the menu by keys "+" or "-".

SETTINGS = values of relay's operation parameters as programmed

F→RELAY = output relays associated to the different functions as programmed.

The SET DISP menu doesn't display current date and time.

12. PROGRAMMING

The relay is supplied with the standard default programming used for factory test.

[Values here below reported (-----)].

All parameters can be modified as needed in the mode PROG and displayed in the mode SET DISP

As soon as programming is enabled, the Led PRG/IRF flashes and the reclosing lock-out relay R5 is deenergized.

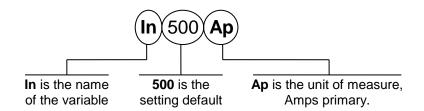
Enter MODE "PROG" and SELECT either "SETTINGS" for programming of parameters or "F→RELAY" for programming of output relays configuration; enable programming by the indirect operation key PROG.

The key SELECT now scrolls the available parameters. By the key (+), (-) the displayed values can be modified; to speed up parameter's variation press the key SELECT while "+" or "-" are pressed.

Press key "ENTER/RESET" to validate the set values.

The setting of the built in clock calendar is described at paragraph 15.2

12.1 - PROGRAMMING OF FUNCTIONS SETTINGS



Mode PROG menu SETTINGS. (Production standard settings here under shown).

Display	Description	Setting range	Step	Unit
xxxxxx	Current date	DDMMMYY	-	-
xx:xx:xx	Current time	HH:MM:SS	-	-
Tsyn DISm	Sync period of the internal clock calendar	5-10-15 30-60-Dis	-	min
Fn 50 Hz	Mains frequency	50 – 60	-	Hz
In 500 Ap	Rated primary current of phase CT's	0 – 9999	1	Α
UnP 10kV	Rated primary phase-to-phase voltage of system's P.T.s	0,1 – 655	10	kV
UnS 100V	Rated secondary phase-to-phase voltage of system's P.T.s	100 – 125	1	V
TLP 60s	Load profiling sampling time	60 – 3600	1	S
Tint 15m	Energy integration time	5 – 15	1	min
WOUT OFF	Enable pulse output for external energy counters	OFF – ON	-	-



Doc. N° MO-0139-ING

Rev. 0

Pag. **16** of **32**

Display	Description	Setting range	Step	Unit
	First voltage element operation mode:		-	
	+ = overvoltage	+		
Un Dis1u	- = undervoltage	-,	-	-
	-/+ = under/over voltage	+/-		
	Dis. = Function is disabled	Dis		
1u 90%Un	Trip differential level of the first voltage control element	5 – 90	1	%Un
	Second voltage element operation mode:			
	+ = overvoltage	+		
Un Dis2u	- = undervoltage	-	-	-
	-/+ = under/over voltage	+/- Dis		
	Dis. = Function is disabled	DIS		
2 u 90 %U n	Trip differential level of the second voltage control element	5 – 90	1	%Un
	First frequency element operation mode:			
	+ = overfrequency	+		
Fn Dis1f	= underfrequency	-	-	-
	-/+ = under/over frequency	+/- Dis		
	Dis. = Function is disabled	DIS		
1f9.99Hz	Trip differential level of the first frequency control element	0,05 - 9,99	0,01	Hz
	Second frequency element operation mode:			
	+ = overfrequency	+		
Fn Dis2f	- = underfrequency	-	-	-
	-/+ = under/over frequency	+/-		
	Dis. = Function is disabled	Dis		
26 0 00H=	Trip differential level of the second frequency control	0.05 0.00	0.01	Hz
2f 9.99 Hz	element	0,05 – 9,99	0,01	ПZ
	First current element operation mode:	+		
	+ = overcurrent	_ T		
In Dis1i	- = undercurrent	+/-	-	-
	-/+ = under/over current	Dis		
	Dis. = Function is disabled	D13		
1i 95%ln	Trip differential level of the first current control element	5 – 95	1	%ln
	Second current element operation mode:	+		
	+ = overcurrent	<u>'</u>		
In Dis2i	- = undercurrent	+/-	-	-
	-/+ = under/over current	Dis		
	Dis. = Function is disabled			
2 i 95%ln	Trip differential level of the second current control element	5 – 95	1	%ln
	First active power element operation mode:	+		
	+ = overpower			
Pn Dis1p	- = underpower	+/-	-	-
	-/+ = under/over power	Dis		
	Dis. = Function is disabled	Dis		
1p 95%Pn	Trip differential level of the first active power control	5 – 95	1	%Pn
1P 30 /0FII	element	J – 3J	'	/01 11



Doc. N° MO-0139-ING

Rev. 0

Pag. 17 of 32

Display	Description	Setting range	Step	Unit
	Second active power element operation mode:			
	+ = overpower	+		
Pn Dis2p	- = underpower	+/-	-	-
	-/+ = under/over power	Dis		
	Dis. = Function is disabled	Dis		
2p 95% P n	Trip differential level of the second active power control	5 – 95	1	%Pn
2 p 93 /61 11	element	3 – 33	'	701 11
	First reactive power element operation mode:	+		
	+ = overpower	<u>'</u>		
Qn Dis1q	- = underpower	+/-	-	-
	-/+ = under/over power	Dis		
	Dis. = Function is disabled	510		
1 q 95% Q n	Trip differential level of the first reactive power control	5 – 95	1	%Qn
14 00 /04.1	element	0 00	·	70 🔾 11
	Second reactive power element operation mode:	+		
	+ = overpower	-		
Qn Dis 2q	- = underpower	+/-	-	-
	-/+ = under/over power	Dis		
	Dis. = Function is disabled			
2q 95% Q n	Trip differential level of the second reactive power control	5 – 95	1	%Qn
•	element			
	First apparent power element operation mode:	+		
C: Diada	+ = overpower	-		
Sn Dis1s	- = underpower	+/-	-	-
	-/+ = under/over power	Dis		
	Dis. = Function is disabled			
1 s 95% S n	Trip differential level of the first apparent power control	5 – 95	1	%Sn
	element Second apparent power element operation mode:			
	+ = overpower	+		
Sn Dis2s	- = underpower	-		_
JII DISZS	-/+ = underpower	+/-		_
	Dis. = Function is disabled	Dis		
	Trip differential level of the second apparent power control			
2s 95% S n	element	5 – 95	1	%Sn
1wDisWtn	Trip level of first active energy element.	5 – 95 – Dis	1	%Wtn
2wDisWtn	Trip level of second active energy element.	5 – 95 - Dis	1	%Wtn
1qDisQtn	Trip level of first reactive energy element.	5 – 95 - Dis	1	%Qtn
2qDisQtn	Trip level of second reactive energy element.	5 – 95 - Dis	1	%Qtn
NodAd 1	Identification number for the connection on serial communication bus	1 - 250	1	-

The setting Dis indicates that the function is disactivated

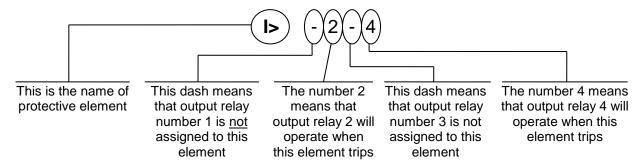


Doc. N° MO-0139-ING

Rev. 0

Pag. 18 of 32

12.2 - PROGRAMMING THE CONFIGURATION OF OUTPUT RELAYS



Mode PROG menu F→RELAY (Production standard settings here under shown).

The key "+" operates as cursor; it moves through the digits corresponding to the four programmable relays in the sequence 1,2,3,4,(1= relay R1, etc.) and makes start flashing the information actually present in the digit. The information present in the digit can be either the number of the relay (if this was already associated to the function actually on programming) or a dot (-) if the relay was not yet addressed.

The key "-" changes the existing status from the dot to the relay number or viceversa.

Disp	lay	Description	
1u		1 st voltage element operates	relays R1, R2, R3, R4
2u		2 ^{ns} voltage element operates	relays R1, R2, R3, R4
1f		1 st frequency element operates	relays R1, R2, R3, R4
2 f		2 ^{ns} frequency element operates	relays R1, R2, R3, R4
1i		1 st current element operates	relays R1, R2, R3, R4
2i		2 ^{ns} current element operates	relays R1, R2, R3, R4
1p		1 st active power element operates	relays R1, R2, R3, R4
2 p		2 ^{ns} active power element operates	relays R1, R2, R3, R4
1q		1 st reactive power element operates	relays R1, R2, R3, R4
2q		2 ^{ns} reactive power element operates	relays R1, R2, R3, R4
1s		1 st apparent power element operates	relays R1, R2, R3, R4
2s		2 ^{ns} apparent power element operates	relays R1, R2, R3, R4
1w		1 st active energy element operates	relays R1, R2, R3, R4
2w		2 ^{ns} active energy element operates	relays R1, R2, R3, R4
1r		1 st reactive energy element operates	relays R1, R2, R3, R4
2r		2 ^{ns} reactive energy element operates	relays R1, R2, R3, R4
Rem		Remote control function operates	relays R1, R2, R3, R4
tFRes	M	Output relays reset mode (M = manual, A = automatic)	



Doc. N° MO-0139-ING

Rev.

Pag. **19** of **32**

13. MANUAL AND AUTOMATIC TEST OPERATION

13.1 Mode "TESTPROG" subprogram "W/O TRIP"

Operation of the yellow key activates a complete test of the electronics and the process routines. All the leds are lit-on and the display shows (TEST RUN). If the test routine is successfully completed the display switches-over to the default reading (current date).

If an internal fault is detected, the display shows the fault identification code and the relay R5 is deenergized. This test can be carried-out even during the operation of the relay without affecting the relay tripping in case a fault takes place during the test itself.

13.2 Mode "TESTPROG" subprogram "WithTRIP"

Access to this program is enabled only if the current detected is zero (breaker open).

Pressing the yellow key the display shows "TEST RUN?". A second operation of the yellow key starts a complete test which also includes the activation of all the output relays.

The display shows (TEST RUN) with the same procedure as for the test with W/O TRIP.

Every 15 min during the normal operation the relay automatically initiates an auto test procedure (duration \leq 10ms). If any internal fault is detected during the auto test, the relay R5 is deenergized, the relevant led is activated and the fault code is displayed.



Running the **WithTRIP** test will operate all of the output relays. Care must be taken to ensure that no unexpected or harmful equipment operations will occur as a result of running this test. It is generally recommended that this test be run only in a bench test environment or after all dangerous output connections are removed.

14. MAINTENANCE

No maintenance is required. Periodically a functional check-out can be made with the test procedures described under MANUAL TEST chapter. In case of malfunctioning please contact Microelettrica Scientifica Service or the local Authorized Dealer mentioning the relay's Serial No reported in the label on relays enclosure.



WARNING

In case of Internal Relay Fault detection, proceed as here-below indicated:

- If the error message displayed is one of the following "DSP Err", "ALU Err", "KBD Err", "ADC Err", switch off power supply and switch-on again. If the message does not disappear send the relay to Microelettrica Scientifica (or its local dealer) for repair.
- □ If the error message displayed is "E2P Err", try to program any parameter and then run "W/OTRIP".
- □ If message disappear please check all the parameters.
- If message remains send the relay to Microelettrica Scientifica (or its local dealer) for repair.

15. POWER FREQUENCY INSULATION TEST

Every relay individually undergoes a factory insulation test according to IEC255-5 standard at 2 kV, 50 Hz 1min. Insulation test should not be repeated as it unusefully stresses the dielectrics. When doing the insulation test, the terminals relevant to serial output must always be short circuited to ground. When relays are mounted in switchboards or relay boards that have to undergo the insulation tests, the relay modules must be drawn-out of their enclosures and the test must only include the fixed part of the relay with its terminals and the relevant connections. This is extremely important as discharges eventually tacking place in other parts or components of the board can severely damage the relays or cause damages, not immediately evident to the electronic components.



Doc. N° MO-0139-ING

Rev. C

Pag. **20** of **32**

16 CLOCK AND CALENDAR

The unit features a built in clock calendar with Years, Months, Days, Hours, Minutes, Seconds, Tenths of seconds and Hundredths of seconds.

16.1 Clock synchronization.

The clock can be synchronized via a digital input (terminals 1-14) or the serial communication interface. The following synchronization periods can be set: 5, 10, 15, 30, 60 minutes. Synchronization can also be disabled, in which case the only way to modify the current date and time is via the front panel keyboard (SETTINGS menu) or the serial communication interface. In case synchronization is enabled, the unit expects to receive a sync signal at the beginning of every hour and once every T_{syn} minutes. When a sync signal is received, the clock is automatically set to the nearest expected synchronization time.

For example: if T_{syn} is 10min and a sync signal is received at 20:03:10 January the 10th, 98, then the clock is set to 20:00:00 January the 10th, 1998.

On the other hand, if the same sync signal were received at 20:06:34, the clock would be set to 20:10:00, January the 10th 98.

Note that if a sync signal is received exactly in the middle of a T_{syn} period, the clock is set to the previous expected synchronization time.

16.2 Date and time setting.

When the PROG/SETTINGS menu is entered, the current date is displayed with one of the groups of digits (YY, MMM or DD) blinking.

The DOWN key operates as a cursor. It moves through the groups of digits in the sequence YY => MMM => DD => YY => ...

The UP key allows the user to modify the currently blinking group of digits.

If the ENTER button is pressed the currently displayed date is captured.

On the other hand pressing the SELECT button leaves the current date unchanged and scrolls the SETTINGS menu. Current time can now be modified using the same procedure described above. If synchronization is enabled and the date (or time) is modified, the clock is stopped until a sync signal is received (via digital input or the serial port). This allows the user to manually set many units and have them to start their clocks in a synchronized fashion.

On the other hand if synchronization is disabled the clock is never stopped.

Note that the setting of a new time always clears 10ths and 100ths of sec.

16.3 Time resolution.

The clock has a 10ms resolution. This means that any event can be time-stamped with a 10ms resolution, although the information concerning 10ths and 100ths of sec. can be accessed only via the serial communication interface.

16.4 Operation during power off.

The unit has an on board Real Time Clock which maintains time information for at least 1 hour in case of power supply failure.

16.5 Time tolerance.

During power on, time tolerance depends on the on board crystal (+/-50ppm typ, +/-100ppm max. over full temperature range).

During power off, time tolerance depends on the RTC's oscillator (+65 –270 ppm max over full temperature range).



Doc. N° MO-0139-ING

Rev. 0

Pag. 21 of 32

17. TIME STAMPING OF MAXIMUM DEMAND VALUES.

Maximum demand values are time stamped by means of the internal clock/calendar. To avoid overloading the MAX VAL menu with too many items, the time stamp is expressed as follows:

- □ Time of the last max. val. reset (DDMMMYY, HH:MM:SS)
- □ For each parameter, time elapsed between the last max. val. reset and the recording of the parameter itself (HH:MM:SS). (max. time is 99:59:59)

Note that all the times are also available with a 10ms resolution via the serial communication interface.

18. ENERGY MEASUREMENTS - ALGORITHMS

The unit calculates both total energy and energy integrated during a definite time (T_{int}). Total energy is simply obtained by integrating power. That is, every second the current value of power is multiplied by 1s and added to total energy according to the following formula:

$$T_ENERGY(t) = T_ENERGY(t-1) + POWER(t) *1s$$

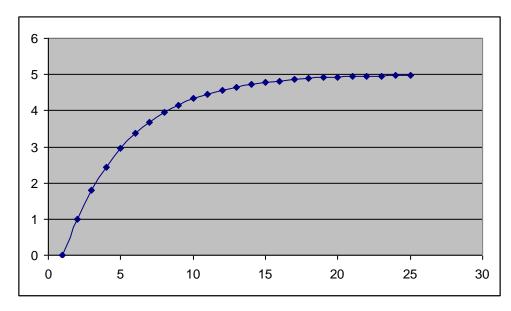
where T_ENERGY(t) stands for total energy at time t.

For what concerns energy integrated in a definite time (D_ENERGY), an approximate calculation is done.

Every second the following algorithm is executed:

D_ENERGY(t) = D_ENERGY(t -1) + POWER(t -1)*1s -
$$\frac{D_ENERGY(t - 1)}{T_{int}}$$
*60

Such algorithm introduces an error. In practice, if we start with D_ENERGY = 0 and inject a constant power, D_ENERGY won't follow a ramp, but an exponential curve. The following example shows what happens if we take POWER = 1 and T_{int} = 5 seconds (impossible value to set, but convenient for an example):





Doc. N° MO-0139-ING

Rev. C

Pag. 22 of 32

To get a faster response the algorithm has been slightly improved:

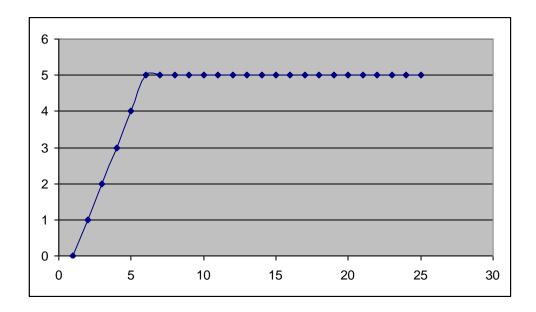
$$IF(t < T_{int})$$

ELSE

$$D_ENERGY = D_ENERGY + POWER *1s - \frac{D_ENERGY}{T_{int} *60}$$

A timer is started as soon as power becomes non-zero (t = 0). During the first T_{int} minutes, D_ENERGY is only incremented. When t reaches T_{int} , we switch back to the old formula. This leads to the following curve (which is just what was expected):

Fig. 2





When a 'reset energy counters' command is sent to the unit, the timer measuring the first T_{int} seconds IS NOT RESET. As a result, D_ENERGY could follow an exponential curve as described in fig. 1



Doc. N° MO-0139-ING
D 4

Rev. **0** Pag. **23** of **32**

19. LOAD PROFILING

When the Load Profiling function is running, the unit periodically calculates the amounts of total active and reactive energies measured during the previous [TLP] seconds and stores such amounts into its non-volatile memory.

The load profiling function is started when a logic 0 to logic 1 transition of the 1-3 digital input is detected (the input is physically shorted). At that time a time-stamp (including current date and time) is stored into the non-volatile memory.

The function runs normally until another 0 to 1 transition of the 1-3 digital input is detected (load profiling stop).

A maximum of couples of energy values (corresponding to 40.5 days when TLP is equal to 3600s) can be stored. When the maximum memory capacity is reached, values are overwritten in a FIFO fashion (oldest samples are overwritten first).

Start and stop commands can be issued to the unit via the serial port also.

Load profiling data is available for reading via the unit's MODBUS serial port. The following paragraphs describe the data retrieval procedure.

19.1 Reading of the demand recording data.

The unit internally represents data according to the following structure, which can be accessed via the serial port:

Offset (word)	Contents
0	Start time: Sec. / 100ths of sec, BCD format
1	Start time: Hours / Min., BCD format
2	Start date: Months / Days, BCD format
3	Start date: 00 / Years, BCD format
4	Index of start sample: 0 to n-1
5	Sampling period
6	Sample 0
6 + n	Sample n

Table 1

Each sample is 16bits (1 word) wide. The LSB (Least Significant Byte) represents active energy as an 8bits signed number, while the MSB (Most Significant Byte) represents reactive energy as an 8 bits signed number. To obtain each energy in p.u. of the rated value, stored samples must be converted to 8 bits signed numbers and then divided by 38.

Example:

Sample (16bits) = 0xF020.

Active Energy => 0x21 => 33 => W = 33 / 38 = 0.868 En Reactive Energy => 0xED => -19 => R = -19 / 38 = -0.5 En



Doc. N° MO-0139-ING

Rev. **0**

Pag. 24 of 32

Note that if the start command is issued via the serial port, the least significant digit of start time is meaningless (due to unpredictable communication delays).

The number of samples stored in the buffers is reset when a start signal is received and incremented every time the relay stores a new sample.

For communication purposes, the memory area represented in Table 1 has been divided into 16 words wide blocks (also called windows). If a word has to be accessed, the proper window must first be selected. To do that, the user has to write the relevant window number to word 11001.

The following table lists the read only words concerning load profiling.

Word Number (MODBUS Address)	Contents
10999	Number of valid samples since last start command
11000	Reserved
11001	Reserved
11002	Max number of samples (7680)
11003	Data available (0 => no , 1 => yes)
11004	Word 0 of currently selected window
11005	Word 1 of currently selected window
11006	Word 2 of currently selected window
11007	Word 3 of currently selected window
11008	Word 4 of currently selected window
11009	Word 5 of currently selected window
11010	Word 6 of currently selected window
11011	Word 7 of currently selected window
11012	Word 8 of currently selected window
11013	Word 9 of currently selected window
11014	Word 10 of currently selected window
11015	Word 11 of currently selected window
11016	Word 12 of currently selected window
11017	Word 13 of currently selected window
11018	Word 14 of currently selected window
11019	Word 15 of currently selected window

<u>Example</u>: to read the start date and time of the currently running demand recording session, the following procedure must be followed:

- 1) Since date/time words have offset ranging from 0 to 3, window 0 must be selected by writing 0 into word #11001.
- 2) Date and time are now available at MODBUS addresses 11004..11007



Doc. N° MO-0139-ING

Rev. 0

Pag. **25** of **32**

20. ELECTRICAL CHARACTERISTICS

APPROVAL: CE - RINA - UL and CSA approval File: E202083

REFERENCE STANDARDS IEC 60255 - EN50263 - CE Directive - EN/IEC61000 - IEEE C37

□ Dielectric test voltage IEC 60255-5 2kV, 50/60Hz, 1 min.

□ Impulse test voltage IEC 60255-5 5kV (c.m.), 2kV (d.m.) - 1,2/50 μ s

□ Insulation resistance > $100M\Omega$

Environmental Std. Ref. (IEC 68-2-1 - 68-2-2 - 68-2-33)

□ Operation ambient temperature -10°C / +55°C
 □ Storage temperature -25°C / +70°C

□ Humidity IEC68-2-3 RH 93% Without Condensing AT 40°C

CE EMC Compatibility (EN50081-2 - EN50082-2 - EN50263)

Electromagnetic emission	EN55022 industrial environment				
Radiated electromagnetic field immunity test	IEC61000-4-3 ENV50204	level 3	80-1000MHz 900MHz/200Hz	10V/m 10V/m	
Conducted disturbances immunity test	IEC61000-4-6	level 3	0.15-80MHz	10V	
Electrostatic discharge test	IEC61000-4-2	level 4	6kV contact / 8kV	air	
Power frequency magnetic test	IEC61000-4-8		1000A/m	50/60Hz	
Pulse magnetic field	IEC61000-4-9		1000A/m, 8/20μs		
Damped oscillatory magnetic field	IEC61000-4-10		100A/m, 0.1-1MHz	<u>z</u>	
Electrical fast transient/burst	IEC61000-4-4	level 3	2kV, 5kHz		
HF disturbance test with damped oscillatory wave (1MHz burst test)	IEC60255-22-1	class 3	400pps, 2,5kV (m.	c.), 1kV (d.m.)	
Oscillatory waves (Ring waves)	IEC61000-4-12	level 4	4kV(c.m.), 2kV(d.r	n.)	
Surge immunity test	IEC61000-4-5	level 4	2kV(c.m.), 1kV(d.r	n.)	
Voltage interruptions	IEC60255-4-11				

CHARACTERISTICS

Resistance to vibration and shocks

Accuracy at reference value of influencing factors	2% for measure 2% +/- 10ms for times				
Rated Current	In = 1A or 5A				
Current overload	200A for 1 sec; 10A continuous				
Burden on current input	Phase : 0.01VA at In = 1A; 0.2VA at In = 5A				
Rated Voltage	Un = 100V (different on request)				
Voltage overload	2 Un continuous				
Burden on voltage input	0,08 VA at Un				
Average power supply consumption	8.5 VA				

Output relays rating 5 A; Vn = 380 V

A.C. resistive switching = 1100W (380V max)

IEC60255-21-1 - IEC60255-21-2 10-500Hz 1g

make = 30 A (peak) 0,5 sec. break = 0.3 A, 110 Vcc, L/R = 40 ms (100.000 op.)

Microelettrica Scientifica S.p.A. - 20089 Rozzano (MI) - Italy - Via Alberelle, 56/68 Tel. (##39) 02 575731 - Fax (##39) 02 57510940 - Telex 351265 MIELIT I http://www.microelettrica.com e-mail : ute@microelettrica.com

The performances and the characteristics reported in this manual are not binding and can modified at any moment without notice

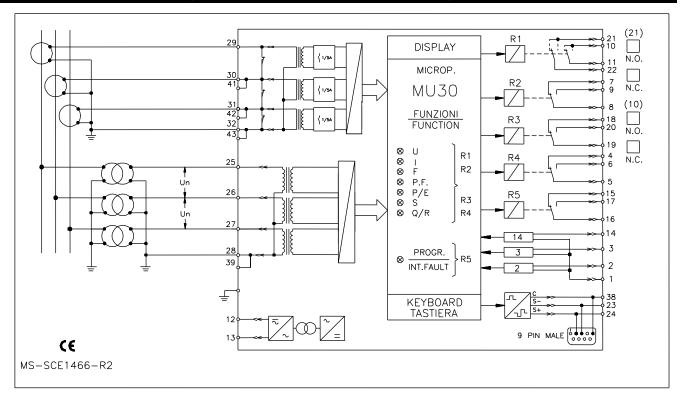


Doc. N° MO-0139-ING

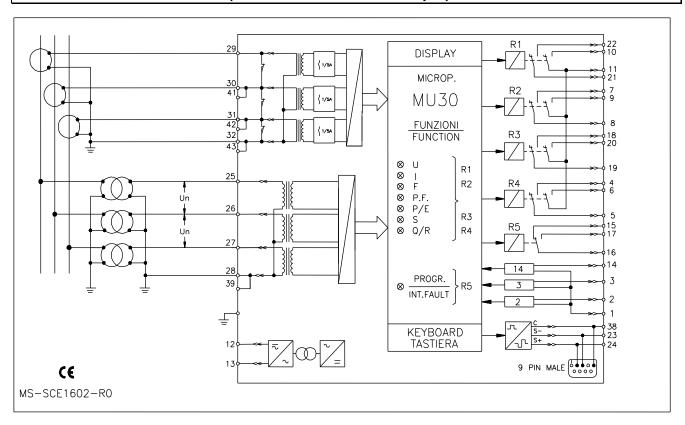
Rev. 0

Pag. **26** of **32**

21. CONNECTION DIAGRAM (SCE1466 Rev.2 STANDARD OUTPUT)



21.1 CONNECTION DIAGRAM (SCE1602 Rev.0 Double Output)





Doc. N° MO-0139-ING

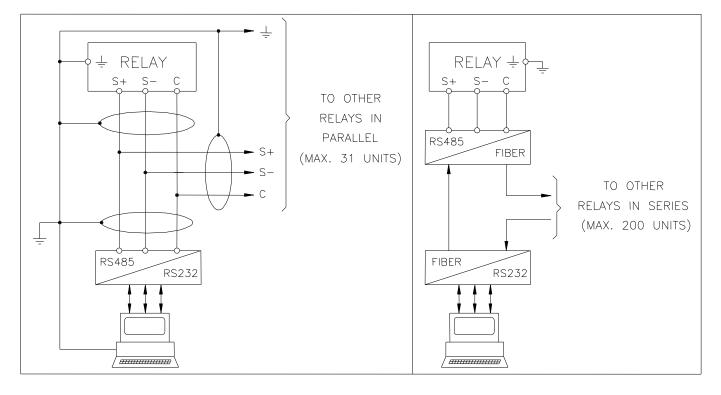
Rev. 0

Pag. **27** of **32**

22. WIRING THE SERIAL COMMUNICATION BUS (SCE1309 Rev.0)

CONNECTION TO RS485

FIBER OPTIC CONNECTION



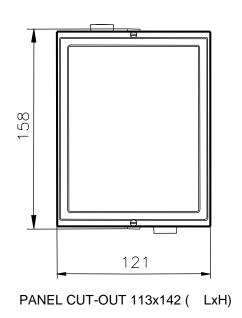


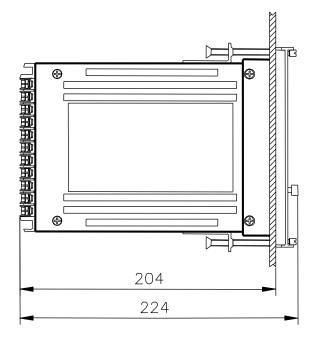
Doc. N° MO-0139-ING

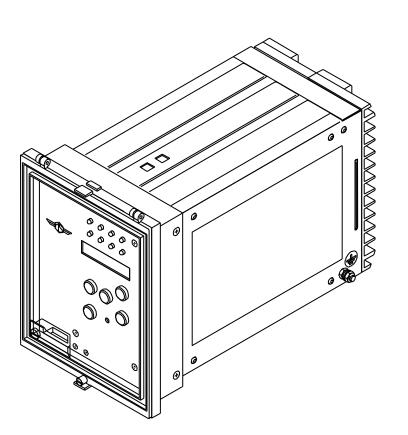
Rev. 0

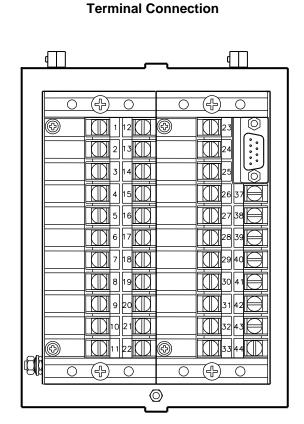
Pag. 28 of 32

23. OVERALL DIMENSIONS









View of Rear



Doc. N° MO-0139-ING

Rev. 0

Pag. 29 of 32

24. DIRECTION FOR PCB'S DRAW-OUT AND PLUG-IN

24.1 Draw-out

Rotate clockwise the screws @ and @ in the horizontal position of the screws-driver mark. Draw-out the PCB by pulling on the handle @

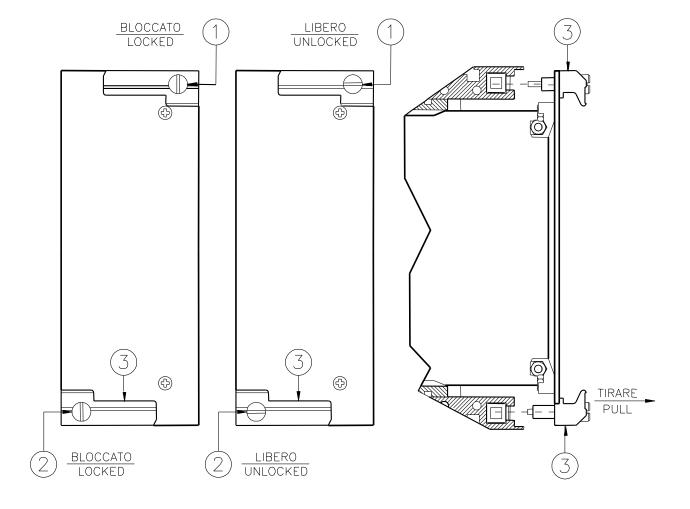
24.2 Plug-in

Rotate clockwise the screws ① and ②in the horizontal position of the screws-driver mark.

Slide-in the card on the rails provided inside the enclosure.

Plug-in the card completely and by pressing the handle to the closed position.

Rotate anticlockwise the screws ① and ② with the mark in the vertical position (locked).



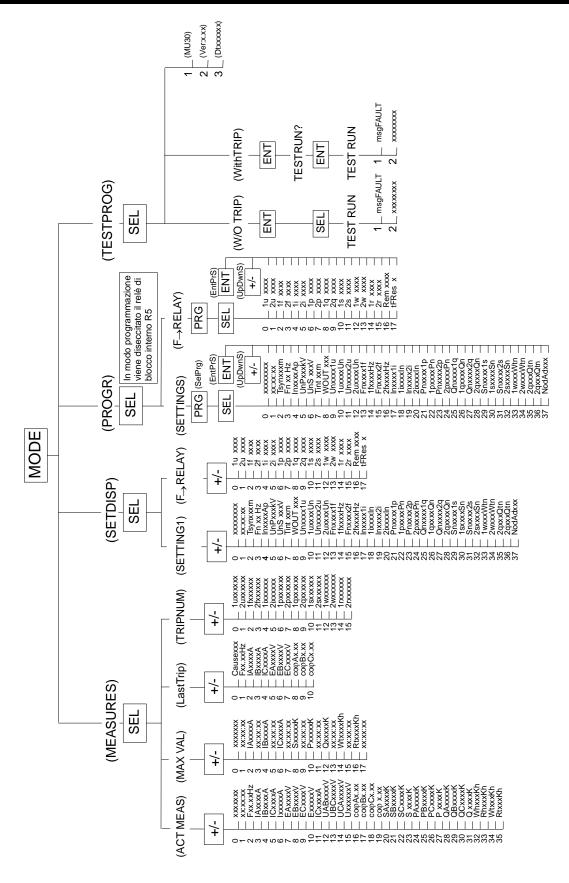


Doc. N° MO-0139-ING

Rev. 0

Pag. 30 of 32

25. KEYBOARD OPERATIONAL DIAGRAM





Doc. N° MO-0139-ING

Rev. 0

Pag. **31** of **32**

26. Setting Form - Commissioning Test Record

Relay Type		MU30-LP Station :				Circ	Circuit :					
Date :		1	1				Rel	ay Se	rial Numbe	er:		
Power Su	nnly	☐ 24V(-20	%) / 110V(+	15%) a.c.	24V(-20%) / 1	125V(+20%)	d.c.					
. ower ouppry									Rated Voltage :			
80V(-20%) / 220V(+15%) a.c. 90V(-20%) / 250V(+20%) d.c. Rated Voltage . RELAY PROGRAMMING												
					RELAT PROG		11		Default	Antonal	Tool 5	II
Variable			Descrip	otion			ting		Default	Actual		
			•				nge		Setting	Setting	Pick-up	Reset
XXXXXX		ent date				DDMMM'		-	random			
XX:XX:XX	Curre	ent time				HH:MM:S		-	random			
Tsyn	Sync	period of the	internal clock	calendar		5-10-15 30-60-D		m	Dis			
Fn	Mains	s frequency				50 - 60		Hz	50			
In	Rated	d primary curre	ent of phase C	CT's		0 – 999	9	Ap	500			
UnP	Rated	d primary phas	se-to-phase vo	oltage of sy	stem's P.T.s	0,1 - 65	5	k۷	10			
UnS	Rated	d secondary p	hase-to-phase	e voltage of	system's P.T.s	100 – 12	25	٧	100			
TLP	Load	profiling samp	oling time			60 – 360	00	s	60			
Tint		gy integration				5 – 15		m	15			
WOUT			t for external		nters	OFF – C		-	OFF			
Un			nt operation n			+, -, +/-, [1u	Dis			
1u	_		el of the first v		rol element	5 – 90		Un	90%			
Un			ment operation		+, -, +/-, [2u	Dis				
2u	_			ontrol element	5 – 90		%Un	90				
Fn			ment operation		+, -, +/-, [1f	Dis				
1f	_		el of the first fr	. ,	introl element	0,05 – 9,		Hz	9.99			
Fn			element opera			+, -, +/-, [2f	Dis			
2f	_				y control element			Hz	9.99			
ln 4:			nt operation m		-1 -1	+, -, +/-, [1i	Dis			
1i			el of the first c		oi element	5 – 95		%ln	95 Dia			
In 2i			ment operatio		ontrol element	+, -, +/-, [5 – 95		2i %ln	Dis 95			
Pn					ontroi element				Dis			
1p			element opera		control element	+, -, +/-, [5 – 95		1p %Pn	95			
Pn			er element op			+, -, +/-, [2p	Dis			
2p			e second activ			5 – 95		%Pn	95			
Qn	_		r element ope			+, -, +/-, [1q	Dis			
1q	Trip	5 – 95		%Qn	95							
Qn						+, -, +/-, [2q	Dis			
2q	Second reactive power element operation mode Trip diff.l level of the second reactive power control element							%Qn	95			
Sn	First apparent power element operation mode:						Dis	1s	Dis			
1s	Trip diff.I level of the first apparent power control element							%Sn	95			
Sn	Second apparent power element operation mode:						Dis	2s	Dis			
2s	Trip diff. level of the second apparent power control element							%Sn	95			
1w	Trip level of first active energy element.						Dis	Wtn	Dis			
2w	Trip level of second active energy element.						Dis	Wtn	Dis			
1q	Trip level of first reactive energy element.						Dis	Qtn	Dis			
2q			d reactive ene		i	5 – 95 - [Dis	Qtn	Dis			
NodAd		ification numb	er for the con	nection on s	serial	1 - 250)	-	1			



Doc. N° MO-0139-ING

Rev. 0

Pag. **32** of **32**

					CONFIGURATION OF OUTPUT RELAYS	·	_			
Default Setting						Actua	Actual Setting			
Protect. Element	Output Relays		Output		Protect. Element	Output Relays				
1u	-	-	-	-	1 st voltage element operates relays	1u				
2u	-	-	-	-	2 ^{ns} voltage element operates relays	2u				
1f	-	-	-	-	1st frequency element operates relays	1f				
2 f	•	-	-	-	2 ^{ns} frequency element operates relays	2f				
1i	-	-	-	-	1st current element operates relays	1i				
2i			-	2 ^{ns} current element operates relays	2i					
1p			-	1st active power element operates relays	1p					
2p			-	2 ^{ns} active power element operates relays	2p					
1q			-	1st reactive power element operates relays	1q					
2q			-	2 ^{ns} reactive power element operates relays	2q					
1s	•	-	-	-	1st apparent power element operates relays	1s				
2s	-	-	-	-	2 ^{ns} apparent power element operates relays	2s				
1w	ı	-	-	-	1st active energy element operates relays	1w				
2w			-	2 ^{ns} active energy element operates relays	2w					
1r	ı	-			1st reactive energy element operates relays	1r				
2r	ı	-	-	-	2 ^{ns} reactive energy element operates relays	2r				
Rem	ı	-	-	-	Remote control function operates relays	Rem				
tFRes M			Output relays reset mode (M = manual, A = automatic)	tFRes						

Commissioning Engineer :	Date :
Customer Witness :	Date :